IEEE P802.11  
Wireless LANs

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| TGbe July 06 2022 Teleconference Minutes | | | | |
| Date: 2022-07-06 | | | | |
| Author(s): | | | | |
| Name | Affiliation | Address | Phone | email |
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| Matthew Fischer | Broadcom |  |  | [Matthew.fischer@broadcom.com](mailto:Matthew.fischer@broadcom.com) |
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Abstract

This document contains the minutes for the July 06 2022 IEEE 802.11 TGbe teleconference.

Revision history:

* Rev0: First version of the document.
* Rev1: Added the participant list for the July 6th meeting.
* Rev2: Updated participant list.
* Rev3: Updated participant list. Added reference to PHY and MAC ad-hoc.

# Wednesday, July 06, Joint (07:00-09:00)

1. The Chair, Alfred Asterjadhi (Qualcomm), calls the meeting to order at 07:00 ET. The Chair notifies the attendees that the agenda is in [11-22-0974r0](https://mentor.ieee.org/802.11/dcn/22/11-22-0974-00-00be-may-july-tgbe-teleconference-agenda.docx).
2. IEEE-SA Policies and Procedure

The chair reviews the IEEE-SA Patent Policy:

If anyone in this meeting is personally aware of the holder of any patent claims that are potentially essential to implementation of the proposed standard(s) under consideration by this group and that are not already the subject of an Accepted Letter of Assurance, please respond at this time by providing relevant information to the WG Chair. Speak up now and respond to this Call for Potentially Essential Patents. **Nobody speaks/writes up**.

1. The chair goes through Other guidelines for IEEE WG meetings, Patent-related information, Participation in IEEE 802 Meetings, and Copyright. The Chair asks that it be minuted that the **Copyright Policy** was presented.
2. Chair provides an attendance reminder:

3.1. Please record your attendance during the conference call by using the IMAT system:

Ueo 1) login to imat, 2) select “802.11 Electronic Plenary(<Month>)” entry, 3) select “C/LM/WG802.11 Attendance” entry, 4) click “TGbe <MAC/PHY/Joint> conference call that you are attending.

* 1. If you are unable to record your attendance contact the Chair Alfred Asterjadhi for assistance
  2. Chair notes that the attendance server is currently down
     1. Jon Rosdahl says that he will attempt to restore the attendance server function. Participants in this call:
* Abouelseoud, Mohamed Apple Inc.
* Aboulmagd, Osama Huawei Technologies Co., Ltd
* Ajami, Abdel Karim Qualcomm Incorporated
* Akhmetov, Dmitry Intel Corporation
* Asterjadhi, Alfred Qualcomm Incorporated
* Au, Kwok Shum Huawei Technologies Co., Ltd
* Baek, SunHee LG ELECTRONICS
* Bankov, Dmitry IITP RAS
* baron, stephane Canon Research Centre France
* Bredewoud, Albert Broadcom Corporation
* Cariou, Laurent Intel Corporation
* Carney, William Sony Group Corporation
* Chemrov, Kirill IITP RAS
* Chitrakar, Rojan Panasonic Asia Pacific Pte Ltd.
* Chng, Shi Baw BAWMAN LLC
* Choi, Jinsoo LG ELECTRONICS
* Chu, Liwen NXP Semiconductors
* CHUN, JINYOUNG LG ELECTRONICS
* Chung, Chulho SAMSUNG
* Coffey, John Realtek Semiconductor Corp.
* de Vegt, Rolf Qualcomm Incorporated
* Dong, Xiandong Xiaomi Inc.
* Erkucuk, Serhat Ofinno
* Fan, Shuang ZTE Corporation
* Fang, Yonggang Mediatek
* Ghosh, Chittabrata Facebook, Inc.
* Gu, Xiangxin Unisoc
* Gupta, Binita Meta Platforms, Inc.
* Haider, Muhammad Kumail Facebook
* Hamilton, Mark Ruckus/CommScope
* Han, Jonghun SAMSUNG
* Handte, Thomas Sony Corporation
* Hirata, Ryuichi Sony Group Corporation
* Ho, Duncan Qualcomm Incorporated
* Hsieh, Hung-Tao MediaTek Inc.
* Hsu, Chien-Fang MediaTek Inc.
* Hsu, Ostrovsky Xiaomi Inc.
* Hu, Chunyu Facebook
* Huang, Guogang Huawei Technologies Co., Ltd
* Huang, Lei Guangdong OPPO Mobile Telecommunications Corp.,Ltd
* Huang, Po-Kai Intel Corporation
* Huq, Kazi Mohammed Saidul Ofinno
* Inohiza, Hirohiko Canon
* Jang, Insun LG ELECTRONICS
* Jung, Insik LG ELECTRONICS
* Kamel, Mahmoud InterDigital, Inc.
* Kasher, Assaf Qualcomm Incorporated
* Khorov, Evgeny IITP RAS
* Kim, Jeongki Ofinno
* Kim, Sang Gook LG ELECTRONICS
* Kim, Sanghyun WILUS Inc
* Kim, Yongho Korea National University of Transportation
* Kim, Youhan Qualcomm Incorporated
* Kishida, Akira Nippon Telegraph and Telephone Corporation (NTT)
* Klein, Arik Huawei Technologies Co., Ltd
* Ko, Geonjung WILUS Inc.
* Koundourakis, Michail Samsung Cambridge Solution Centre
* Lalam, Massinissa SAGEMCOM BROADBAND SAS
* Lalitte, Vanessa IEEE SA
* Lanante, Leonardo Ofinno
* Lee, Wookbong SAMSUNG
* Levesque, Chris Qorvo
* Levitsky, Ilya IITP RAS
* Li, Jialing Qualcomm Technologies, Inc.
* li, yan ZTE Corporation
* Li, Yapu Guangdong OPPO Mobile Telecommunications Corp.,Ltd
* Li, Yunbo Huawei Technologies Co., Ltd
* Lim, Dong Guk LG ELECTRONICS
* Liu, Der-Zheng Realtek Semiconductor Corp.
* Liu, Yong Apple, Inc.
* Loginov, Vyacheslav IITP RAS
* Lorgeoux, Mikael Canon Research Centre France
* Lou, Hanqing InterDigital, Inc.
* Lu, kaiying MediaTek Inc.
* Lu, Liuming Guangdong OPPO Mobile Telecommunications Corp.,Ltd
* Lyakh, Mikhail ON Semiconductor
* Ma, Li MediaTek Inc.
* Medda, Daniele International Hellenic University
* Mehrnoush, Morteza Facebook
* Monajemi, Pooya Cisco Systems, Inc.
* Montemurro, Michael Huawei Technologies Co., Ltd
* Moon, Juseong Korea National University of Transportation
* Mutgan, Okan Nokia
* Naik, Gaurang Qualcomm Incorporated
* NANDAGOPALAN, SAI SHANKAR Synaptics
* Nayak, Peshal Samsung Research America
* Nezou, Patrice Canon Research Centre France
* Ng, Boon Loong Samsung Research America
* noh, yujin Senscomm
* Ouchi, Masatomo Canon
* Park, Eunsung LG ELECTRONICS
* Park, Minyoung Intel Corporation
* Park, Sungjin Senscomm
* Patil, Abhishek Qualcomm Incorporated
* Rai, Kapil Qualcomm Incorporated
* Ratnam, Vishnu Samsung Research America
* Redlich, Oded Huawei Technologies Co., Ltd
* Rosdahl, Jon Qualcomm Technologies, Inc.
* Ryu, Kiseon Ofinno
* Sato, Takuhiro SHARP CORPORATION
* Schelstraete, Sigurd MaxLinear
* Sevin, Julien Canon Research Centre France
* Shafin, Rubayet Samsung Research America
* Shilo, Shimi Huawei Technologies Co., Ltd
* Shirakawa, Atsushi SHARP CORPORATION
* SUH, JUNG HOON Huawei Technologies Co., Ltd
* Sun, Li-Hsiang Sony Corporation
* Sun, Yanjun Qualcomm Incorporated
* Tanaka, Yusuke Sony Group Corporation
* Taori, Rakesh Infineon Technologies
* Tian, Bin Qualcomm Incorporated
* Torab Jahromi, Payam Facebook
* Tsodik, Genadiy Huawei Technologies Co., Ltd
* Varshney, Prabodh Nokia
* VIGER, Pascal Canon Research Centre France
* Wang, Chao Chun MediaTek Inc.
* Wang, Hao Tencent
* Wang, Lei Futurewei Technologies
* Wang, Qi Apple, Inc.
* Wang, Xiaofei InterDigital, Inc.
* Wei, Dong NXP Semiconductors
* Wu, Kanke Qualcomm Incorporated
* Wu, Tianyu Apple, Inc.
* Wullert, John Peraton Labs
* Xin, Liangxiao Sony Corporation
* Xin, Yan Huawei Technologies Co., Ltd
* Xu, Fangxin Longsailing Semiconductor
* Yang, Jay Nokia
* YANG, RUI InterDigital, Inc.
* Yano, Kazuto Advanced Telecommunications Research Institute International (ATR)
* Yee, James MediaTek Inc.
* Yi, Yongjiang Spreadtrum Communication USA, Inc
* Yu, Jian Huawei Technologies Co., Ltd
* Zhang, Jiayi Ofinno
* Zhou, Lei H3C Technologies Co., Limited
* Zhou, Pei Guangdong OPPO Mobile Telecommunications Corp.,Ltd

1. Announcements:
   1. TGbe LB266 D2.0 has completed and failed with ~64% Approve
   2. No secretary has volunteered
2. Chair notes that attendance server is back up
3. Editor comments
   1. Note that nine 802.19 comments included in the TGbe comment spreadsheet
4. Agenda:
   1. Chair reviews proposed agenda
   2. Discussion:

None

* 1. Agenda approved with unanimous consent.

1. Editor’s report [11-22-0972r1](https://mentor.ieee.org/802.11/dcn/22/11-22-0972-01-00be-tgbe-editor-s-report-on-lb266.ppt)
   1. Editor reviews contents of the editor’s report document [11-22-0972r1](https://mentor.ieee.org/802.11/dcn/22/11-22-0972-01-00be-tgbe-editor-s-report-on-lb266.ppt)
   2. Editor has categorized the comments
   3. No questions for the editor
2. Hybrid meeting details
   1. Chair discusses TGbe meeting plan for the July Montreal meeting, see [11-22-0974r0](https://mentor.ieee.org/802.11/dcn/22/11-22-0974-00-00be-may-july-tgbe-teleconference-agenda.docx)
3. Editor asks attendees to send emails to indicate specifically whether they will volunteer as POC (Point of Contact) or TTT participant for CIDs
   1. Discussion:

C: Volunteers will be added to the spreadsheet?

C: what will be added to the assignee column?

A: POC, and additional volunteers in the notes column

A: POC should send a list of CIDs to the editor

A: best to indicate a subclause rather than a list of CIDs, this makes it easier to manage the database

C: looking at 11-22-0971r0 – will each subclause have a POC?

C: hope to complete joint CIDs today, remaining comments by the end of the week

C: Need to upload document by Sunday, or just request by Sunday?

A: only request by Sunday

1. LB266 Joint Comment assignments
   1. Editor presents the comment doc [11-22-0974r0](https://mentor.ieee.org/802.11/dcn/22/11-22-0974-00-00be-may-july-tgbe-teleconference-agenda.docx)
   2. Editor reviews subclauses that have comments, looking for volunteers for POC
2. CR Submissions:
   1. No time remaining in the call for CR submission presentations
3. AoB: No other business.
4. Recess at 09:00 ET

# Thursday July 7th, 2022 10:00 – 12:00 ET

This was a split MAC/PHY call:

* PHY: <https://mentor.ieee.org/802.11/dcn/22/11-22-1103-00-00be-minutes-for-tgbe-phy-ad-hoc-cc-may-2022-to-july-2022.docx>
* MAC: <https://mentor.ieee.org/802.11/dcn/22/11-22-1041-01-00be-mac-minutes-for-tgbe-ad-hoc-teleconferences-in-may-and-july-2022.docx>